



MLG10N-0140C10594

MLG-2

MEASURING AUTOMATION LIGHT GRIDS

SICK
Sensor Intelligence.



Illustration may differ



Ordering information

Type	Part no.
MLG10N-0140C10594	1138798

Other models and accessories → www.sick.com/MLG-2

Detailed technical data

Features

Device version	ProNet - Advanced functionality incl. fieldbus				
Sensor principle	Sender/receiver				
Minimum detectable object (MDO)	10 mm, 14 mm ^{1) 2) 3)}				
Beam separation	10 mm				
Type of synchronization	Cable				
Number of beams	15				
Detection height	140 mm				
Operating mode	Standard ✓ Transparent ✓ Dust- and sunlight-resistant ✓				
Function	Cross beam ✓ Beam blanking ✓ High measurement accuracy ✓				
Applications	<table border="0"> <tr> <td style="vertical-align: top;">Switching output</td> <td>Object recognition/object width Object recognition Height classification Hole detection/hole size Outside dimension/inside dimension Object position Hole position Zone definition</td> </tr> <tr> <td style="vertical-align: top;">Data interface</td> <td>Object detection Hole detection Object height measurement</td> </tr> </table>	Switching output	Object recognition/object width Object recognition Height classification Hole detection/hole size Outside dimension/inside dimension Object position Hole position Zone definition	Data interface	Object detection Hole detection Object height measurement
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Data interface	Object detection Hole detection Object height measurement				

¹⁾ MDO min. detectable object at high measurement accuracy.

²⁾ MDO min. detectable object for standard measurement accuracy.

³⁾ Depending on beam separation without cross beam setting.

	Measurement of external dimension Measurement of inside dimension Measurement of object position Measurement of hole position
Included with delivery	1 × sender 1 × receiver 1 x Fieldbus module 4/6 x QuickFix brackets (6 x QuickFix brackets for monitoring heights above 2 m) 1 × Quick Start Guide

- 1) MDO min. detectable object at high measurement accuracy.
2) MDO min. detectable object for standard measurement accuracy.
3) Depending on beam separation without cross beam setting.

Mechanics/electronics

Light source	LED, Infrared light
Wave length	850 nm
Supply voltage V_s	DC 19.2 V ... 28.8 V ¹⁾
Power consumption sender	56.7 mA ²⁾
Power consumption receiver	123.8 mA ²⁾
Fieldbus module current consumption	115 mA
Ripple	< 5 V _{pp}
Output current I_{max}	100 mA
Output load, capacitive	100 nF
Output load, Inductive	1 H
Initialization time	< 1 s
Switching output	Push-pull: PNP/NPN
Connection type	Male connector M12, 5-pin, 0.22 m Connector M12, 12-pin, 0.21 m
Housing material	Aluminum
Indication	LED
Enclosure rating	IP65, IP67 ³⁾
Circuit protection	U _V connections, reverse polarity protected Output Q short-circuit protected Interference pulse suppression
Protection class	III
Weight	0.549 kg
Front screen	PMMA
Option	None
UL File No.	NRKH.E181493

- 1) Without load.
2) Without load with 24 V.
3) Operating in outdoor condition only with a external protection housing.

Performance

Maximum range	7 m ¹⁾
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- 1) No reserve for environmental issue and deterioration of the diode.
2) Without high speed.

Minimum range	≥ 0 m
Operating range	5 m
Response time	3.5 ms ²⁾

¹⁾ No reserve for environmental issue and deterioration of the diode.

²⁾ Without high speed.

Communication interface

CANopen	✓
Data transmission rate	10 kbit/s ... 1 Mbit/s
Digital output	Q ₁
Number	1

Ambient data

Shock resistance	Continuous shocks 10 g, 16 ms, 1000 shocks Single shocks 15 g, 11 ms 3 per axle
Vibration resistance	Sinusoidal oscillation 10-150 Hz 5 g
EMC	EN 60947-5-2
Ambient light immunity	Direct: 150,000 lx ¹⁾ Indirect: 200,000 lx ²⁾
Ambient operating temperature	-30 °C ... +55 °C
Ambient temperature, storage	-40 °C ... +70 °C

¹⁾ Outdoor mode.

²⁾ Light resistance indirect.

Classifications

ECLASS 5.0	27270910
ECLASS 5.1.4	27270910
ECLASS 6.0	27270910
ECLASS 6.2	27270910
ECLASS 7.0	27270910
ECLASS 8.0	27270910
ECLASS 8.1	27270910
ECLASS 9.0	27270910
ECLASS 10.0	27270910
ECLASS 11.0	27270910
ECLASS 12.0	27270910
ETIM 5.0	EC002549
ETIM 6.0	EC002549
ETIM 7.0	EC002549
ETIM 8.0	EC002549
UNSPSC 16.0901	39121528

Dimensional drawing (Dimensions in mm (inch))

Dimensional drawing



Beam separation 2.5 mm	62.25 (2.45)	17.15 (0.68)
Beam separation 5 mm	63.3 (2.49)	16.1 (0.63)
Beam separation 10 mm	68.3 (2.69)	16.1 (0.63)
Beam separation 20 mm	68.3 (2.69)/78.3 (3.08) ³⁾	16.1 (0.63)
Beam separation 25 mm	83.3 (3.28)	16.1 (0.63)
Beam separation 30 mm	88.3 (2.69)	16.1 (0.63)
Beam separation 50 mm	108.3 (4.26)	16.1 (0.63)

¹⁾ Distance: MLG-2 edge - first beam

²⁾ Distance: MLG-2 edge - last beam

³⁾ MLG20x-xx40: 68.3 mm

MLG20x-xx80: 78.3 mm

- ① First beam
- ② Last beam
- ③ Detection height (see technical data)

- ④ Beam separation
- ⑤ Optical axis
- ⑥ Status indicator: green, yellow, red LEDs
- ⑦ Connection
- ⑧ Safty screw M4; turning moment 0,5 Nm
- ⑨ For thread bold M4; turning moment 0,5 Nm

Connection type and diagram

CANopen



- ① Connection to fieldbus module
- ② Not connected

Pinouts

Ethernet



- ① Connection cable receiver (2096010)
- ② T-piece
- ③ Connection cable (2096240)
- ④ Connection receiver "DEVICE"
- ⑤ Connection cable "POWER" (2096010)
- ⑥ Ethernet Connection cable "BUS IN, BUS OUT"
- ⑦ Ethernet connection cable "CONFIG"

Adjustments



① Status indicator: green, yellow, red LEDs

Connection diagram

T-piece



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